



APTEK LABORATORIES, INC.

ISO 9001 / AS9100 Certified

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TECHNICAL DATA & INFORMATION

UVIKOTE™ 7503LMAUTO-PMF

UV Curing, Low Modulus, Low Outgassing, Urethane Conformal Encapsulant/Coating

PRODUCT DESCRIPTION

UVIKOTE 7503LMAUTO-PMF is a low viscosity, ready to spray, one component, premixed frozen liquid, electrically insulating, transparent, urethane coating designed for the encapsulation and protection of electrical/electronic components mounted on printed circuit boards. This system provides an excellent combination of flexibility and low modulus for demanding applications where the management of thermomechanical stresses is required.

UVIKOTE 7503LMAUTO-PMF coating will become tack free when exposed to the proper UV light radiation. The coating will fully post cure in both the exposed and shaded areas in 14 days at 25°C and 50% relative humidity. As an alternative, the post cure for the coating in both exposed and shaded areas may be accelerated with low to moderate heat.

KEY FEATURES AND BENEFITS

- Qualified to **Mil-I-46058C** and **IPC-C-830C**
- Multicure mechanism for complete cure in shaded areas underneath components
- Excellent flexibility and low modulus, low Tg, for reduced stress in the encapsulation of sensitive components (e.g. glass-bodied diodes)
- Meets NASA condensable volatile requirements for high vacuum environments
- Highly reversion resistant for good physical stability under high heat and humidity environments
- Excellent adhesion to plastic/metal components and substrates. Adheres well to itself for multicoat and repair applications
- Ready-to-spray viscosity formulated to have specific viscosity range for automated equipment
- No TDI, toxic solvents, or free acrylic acid for safety
- Complete companion UV product line available:
 - UVIKOTE 7504LM-PMF – 100% solids for thicker applications such as the back-side solder joint encapsulation
 - UVISTAKE™ 7205LM-PMF – thixotropic, non-flow adhesive for wire tacking and component staking
 - UVIKOTE 7503, 7504 Thinner – non-photosensitive, non-aromatic, thinner for lowering viscosity of UVIKOTE 7503LM-PMF, UVIKOTE 7503LMAUTO-PMF, and UVIKOTE 7504LM-PMF

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- UVIKOTE S-100 Stripper – low viscosity stripper for the removal of cured coating/adhesive for repair operations
- UVIKOTE S-200 Stripper – thixotropic stripper for localized removal of cured coating/adhesive

HANDLING INFORMATION

1. Work Life, after thaw @ 25°C, 200 gm mass, hrs. > 8

Notes:

- To thaw remove sealed container from freezer and allow to warm to room temperature. Leave cap on until ready to use. Do not place in oven or microwave to thaw - this will shorten work life. Typical time to thaw 8 oz bottle is approximately 30 minutes.
- UVIKOTE 7503LM-AUTO-PMF should not need to be thinned, this product has been formulated to have a specific viscosity to work with automated equipment.

2. Once thawed, material is ready for use. For automated dispensing equipment pour amount needed into reservoir and purge with dry air. Unused material may be refrozen - however, purge with dry air prior to resealing and placement into freezer @ -40°C or below.

Note: Refrozen material can re-used as needed as long as the solvent has not been allowed to significantly evaporate to where it is too thick to spray/curtain coat. The used material can also be replenished with fresh material or diluted with thinner to extend work-life and lower the viscosity.

3. Work life adversely affected by heat and humidity as well as solvent evaporation.

4. Work life can be extended by additions of thinner and/or periodical replenishment of freshly mixed **UVIKOTE 7503LMAUTO-PMF**. **Note:** Thinner should only be used to replace solvent from evaporation. Evaporation can be minimized by keeping holding containers covered.

5. Bottles of **UVIKOTE 7503LMAUTO-PMF** are shipped in dry ice. Upon receipt, transfer frozen containers to a storage freezer @ -40°C or below.

6. UVIKOTE 7503LMAUTO-PMF has excellent adhesion to itself and the companion line of products. Multiple thin coats of material can be applied. Aptek Laboratories recommends that UVIKOTE 7503LMAUTO-PMF is fully cured to include post cure if final coating thickness exceeds 5 mils thick.

CURE SCHEDULE

U.V. Cure with Conveyor Equipment

3-4 passes under 300 W/in Fusion UV, D-bulb lamp at rate of 2 feet per min. OR 2-3 passes under 300 W/in fusion UV, D-bulb @ rate of 1 foot per min. Bulb height above coating surface should be adjusted to expose the resin system to approximately ~17.5 joules/cm² of radiation per pass at 1 foot/minute and ~12 joules/cm² of radiation per pass at 2 feet/minute. The minimum total amount of joules that needs to be achieved to fully UV-cure this product is ≥36 joules/cm².

U.V. Cure with Spot Cure Equipment

We recommend using an EFOS Novacure or equivalent equipment with similar power generating capabilities. This system is capable of generating the same amount of energy as in cure #1. In some applications, diffusers may be necessary to insure even energy distribution and complete cure. Customer should consult Aptek Laboratories and/or equipment supplier to optimize cure for individual applications.

Postcure

After curing as indicated in steps 1 or 2 above, the coating can be postcured as follows:

- a) 14 days at 25°C and 50% relative humidity
- OR
- b) 4 hours at 100°C, or 6 hours at 85°C, or 12 hours at 65°C

-PLUS-

One of the two following RT post-cures:

- 1. **NORMAL PRODUCTION USE:** As typical with urethane systems, a relaxation/stabilization period of 3-5 days at RT, 30-60% RH, after cure is required before normal testing, service, or use.

-OR-

- 2. **DIRECT MIL-SPEC TESTING:** If the coated circuit boards are to be directly tested to the rigors of Mil I 46058C, let heat-cured boards post cure @ RT and 30-65% RH for a minimum of 14 days prior to testing. If RH is below 30%, longer time may be required for ultimate cure.

Note:

- 1) The above cure schedules are conservative and should be used as guidelines only. User should determine proper cure schedule based on application requirements and properties desired.
- 2) Cured material exposed to excess heat and long term aging may darken in color over time. Please note that this is a natural occurrence and no adverse effects to mechanical or electrical properties take place.

TYPICAL PROPERTIES
(not for specification purposes)

<u>CHARACTERISTICS</u>	<u>7503LMAUTO-PMF</u>	<u>TEST METHOD</u>
Color	Slightly haze, yellow/amber	Visual
Specific gravity	0.91	ASTM D-1475
Viscosity @ 25°C,cps	65	ASTM D-1824
Flash point, °C	>100°C	TCC
Shelf life @-40°C, or below, months in factory sealed containers	6	

<u>CURED PHYSICAL PROPERTIES</u>	<u>7503LMAUTO-PMF</u>	<u>TEST METHOD</u>
Glass transition temp., °C	-55	ASTM E831-86
Thermal coefficient of expansion, in/in/°C		
alpha 1	82 x 10 ⁻⁶	ASTM E831-86
alpha 2	222x 10 ⁻⁶	

Outgassing @ 10⁻⁶ Torr

(Cure schedule:

36 joules per 300 Watt Fusion D bulb +

Post cure of 6 hours @ 85C

OR 4 hours @ 100C)

TML, %	0.45	ASTM E-595
CVCM, %	0.02	ASTM E-595
Young's modulus, psi		
@55°C	450	
@25°C	700	
@-40°C	9500	
Evidence of haze	None	ASTM E-595
Fungus resistance	Non-nutrient	ASTM G-21

CURED ELECTRICAL PROPERTIES**7503LMAUTO-PMF****TEST METHOD**

Volume resistivity, @25°C, ohm-cm*	4.0 x 10 ¹⁴	ASTM D-257
Dielectric constant, @1KHz, @25°C*	3.2	ASTM D-150
Dissipation factor @1KHz, @25°C*	0.03	ASTM D-150
Dielectric strength, 0.003" thick* film, volts/mil	>1500	ASTM D-149
Insulation resistance, ohms	1.0 x 10 ¹⁴	MIL-I-46058C

* Tested on unsolvated castings @ 0.100" thickness

SAFETY AND FIRST AID

UVIKOTE 7503LMAUTO-PMF is an unfilled organic polyol isocyanate/acrylate blend resin containing solvent and is thus considered a flammable liquid and should be treated with caution. Store @ -40°C or below and keep away from flame, sparks, or other sources of ignition. Use in well-ventilated area and avoid breathing vapors. In case of eye contact, flush with fresh clean water for at least 15 minutes; for skin contact, wash thoroughly with soap and water. If swallowed, drink at least one pint of water and call a physician. Refer to Material Safety Data Sheet for more details.

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